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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/940,567	08/27/2001	Pamela S. Trammel	LWM-A110	5034	
7	590 04/03/2003				
WAGNER, MURABITO & HAO LLP			EXAMINER		
Third Floor Two North Ma			VOCKRODT, JEFF B		
San Jose, CA	95113	••	ART UNIT	VOCKRODT, JEFF B ART UNIT PAPER NUMBER	
		2822			

Please find below and/or attached an Office communication concerning this application or proceeding.

. :	Appl	ication No.	Applicant(s)		
Office Action Summary		40,567	TRAMMEL ET AV.		
		niner	Art Unit		
The MAILING DATE of this	Jeff \	Vockrodt	2822		
The MAILING DATE of this com-	munication appears o	n the cover sheet with the	correspondence address		
A SHORTENED STATUTORY PERIOTHE MAILING DATE OF THIS COMM - Extensions of time may be available under the provious after SIX (6) MONTHS from the mailing date of this - If the period for reply specified above is less than the - If NO period for reply is specified above, the maximus - Failure to reply within the set or extended period for - Any reply received by the Office later than three more - armed patent term adjustment. See 37 CFR 1.704(ions of 37 CFR 1.136(a). In a communication, irty (30) days, a reply within thum statutory period will apply a reply will, by statute, cause the mailing date of the mail of the mail of the safer.	no event, however, may a reply be ti e statutory minimum of thirty (30) da and will expire SIX (6) MONTHS fror	imely filed lys will be considered timely. In the mailing date of this communication.		
Status					
1) Responsive to communication(s					
2a)⊠ This action is FINAL.	2b)☐ This actio				
3) Since this application is in cond closed in accordance with the p Disposition of Claims	lition for allowance ex practice under <i>Ex part</i>	cept for formal matters, p e Quayle, 1935 C.D. 11,	rosecution as to the merits is 453 O.G. 213.		
4)⊠ Claim(s) <u>1-22</u> is/are pending in t	the application.				
4a) Of the above claim(s)		consideration.			
5)⊠ Claim(s) <u>9-22</u> is/are allowed.					
6)⊠ Claim(s) <u>1,2,4,7 and 8</u> is/are reje	ected.				
7) Claim(s) 3,5 and 6 is/are objected					
8) Claim(s) are subject to res		n requirement			
Application Papers		4			
9)☐ The specification is objected to by	the Examiner.				
10)☐ The drawing(s) filed on is/a	ire: a)⊟ accepted or b	objected to by the Exa	miner.		
Applicant may not request that any	objection to the drawing	g(s) be held in abeyance. S	ee 37 CFR 1.85(a).		
11)∐ The proposed drawing correction f	filed on is: a)[_] approved b) [] disappro	ved by the Examiner.		
If approved, corrected drawings are		Office action.			
12)☐ The oath or declaration is objected	to by the Examiner.				
Priority under 35 U.S.C. §§ 119 and 120					
13)☐ Acknowledgment is made of a cla	aim for foreign priority	under 35 U.S.C. § 119(a))-(d) or (f).		
a) ☐ All b) ☐ Some * c) ☐ None o	f:				
 Certified copies of the priori 	ity documents have b	een received.			
2. Certified copies of the priority documents have been received in Application No					
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 					
14) Acknowledgment is made of a claim a) The translation of the foreign I	language provident	under 35 U.S.C. § 119(e)) (to a provisional application).		
a) ☐ The translation of the foreign l 15)☐ Acknowledgment is made of a clain	ianguage provisional a n for domestic priority	application has been rece	eived.		
Attachment(s)	priority		anu/ULIZI.		
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review 3) Information Disclosure Statement(s) (PTO-1449)	(PTO-948) Paper No(s)	4) Interview Summary (5) Notice of Informal Pa	(PTO-413) Paper No(s) atent Application (PTO-152)		
5. Patent and Trademark Office TO-326 (Rev. 04-01)	Office Action Summ	narv	Part of Paper No. 5		

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1.

DETAILED ACTION

This office action is in response to the amendment filed on January 21, 2003. Claims 1-22 are pending.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-2, 4, and 7-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Pat. No. 6,507,681 ("Kowalczyk") in view of WO 01/06547 ("Huttemann").

Claim 1 corresponds to Kowalczyk as follows (with the differences underlined): A method for making a resistive heater for a planar lightwave circuit, the method comprising the steps of: a) depositing a resistive layer (heater 660; Fig. 6) on a top clad of a planar lightwave circuit (cladding layer 620); b) depositing an interconnect layer (layer for contact stripes 662) onto the resistive layer (660) (both the heater layer 660 and the contact stripes layer 662 are deposited before being patterned as they are deposited "in the same pumpdown" col. 10, II. 20-26); c) etching the interconnect layer to define a heater interconnect, wherein the heater interconnect is disposed over the resistive layer and has a first width (Kowalczyk first etches the interconnect layer and the resistive layer in a single step--this meets clause c because of the open-ended nature (i.e., "comprising" transitional phrase) of the claim; col. 10, II. 27-41); d) masking the heater interconnect (the second photoresist is applied over the interconnect; col. 10, 41-47); and e) etching the resistive layer to define a resistive heater, wherein the resistive

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heater is disposed beneath the heater interconnect¹ and has a second width (width is taken along the axis that intersects both resistor contacts) larger than the first width.

Clause (e) is interpreted to impose order on the method steps such that the steps in clause (c) and (e) must be performed in their written order to be anticipated.² That is, claim 1 requires etching the contacts before patterning and etching the resistor. Kowalczyk differs in this aspect by etching the resistive layer and then etching the contacts to form the resistor shown in Fig. 6.

Huttemann teaches a thin film resistor that is patterned by etching the contacts (920,930; Fig. 10) followed by etching the resistor material (810, 1120; compare Figs. 10-11). Huttemann teaches that this manner of patterning can provide self-alignment (page 13, lines 17-25).

Kowalczyk and Huttemann are analogous art as they both concern forming thin film resistors.

It would have been obvious to one of ordinary skill in the art at the time of the invention to form the thin film resistor by patterning the contacts and then the resistor material in Kowalczyk. One of ordinary skill in the art would have been motivated to do this by Huttemann's teaching that self alignment is possible with this sequence.

Claim 2. The heater or resistive element is between a first and second contact pad, and current flows through the resistive element.

Claim 4. As discussed above, Huttemann teaches self-alignment.

¹ Kowalczyk teaches both etching the resistive layer and a resistive heater disposed beneath the heater interconnect, but as will be discussed in more detail below, does not fully meet clause (e) of claim 1 as a whole.

² While the steps recited in method claims need not necessarily be performed in their written order, claim 1 implicitly requires performing the step of clause (e) subsequent to the step of clause (c) since clause (e) refers to the "heater interconnect" that is defined in clause (c). See Loral Fairchild Corp. v. Sony Electronics Corp., 181 F.3d 1313, 1321, 50 USPQ2d 1865, 1870 (Fed. Cir. 1999) (holding that the claim language itself indicated that the claim steps had to be performed in their written order because the second step required the alignment of a second structure with a first structure formed by the prior step.).

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Claims 7-8. Kowalczyk teaches etching the resistive layer using a plasma etcher which suggests a reactive ion etching process.

Allowable Subject Matter

Claims 9-22 are allowed. Claims 3, 5, and 6 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Claims 3 and 9-22 differ from Kowalczyk and Huttemann taken together by requiring in addition to the steps of claim 1, including the sequence of etching the interconnect layer . . . masking the heater interconnect . . . and etching the resistive layer, wherein the resistive layer comprises tungsten and the interconnect layer comprises aluminum. In contrast, Huttemann teaches a contact pad of Ti/Pt and a resistive layer of Ta₂N or NiCr; and Kowalczyk teaches a contact pad of Au and a resistive layer of NiCr. Accordingly, none of the references of record taken alone or in combination with each other teach the sequence and materials required by claims 3 and 9-22.

Claims 5-6 differ from Kowalczyk and Huttemann taken together by requiring in addition to the steps of claim 1, including the sequence of etching the interconnect layer . . . masking the heater interconnect . . . and etching the resistive layer, etching the interconnect layer using a dry etch process. In contrast, Huttemann teaches a wet etching process for patterning the Ti/Pt layer and Kowalczyk teaches a "standard commercial gold etch," which is a wet etch.

Accordingly, none of the references of record taken alone or in combination with each other teach the sequence and materials required by claims 5-6.

Response to Arguments

Applicant's arguments with respect to claims 1-22 have been considered but are moot in view of the new ground(s) of rejection.

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Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

U.S. Pat. No. 6,424,755 ("Clapp"). Clapp teaches a method for making a resistive heater (Fig. 3) for a planar lightwave circuit, the method comprising the steps of: (a) depositing a resistive layer (34) on a top clad (33) of a planar lightwave circuit (31, 32, 33); (b) depositing an interconnect layer (35) onto the resistive layer (34). Like Kowalczyk, which is applied above, Clapp does not teach etching the interconnect layer and then etching the resistive layer as required by the claims.

U.S. Pat. No. 6,285,542 ("Kennedy"). Kennedy teaches a method of forming a thin film resistor that involves patterning and etching the resistive layer after patterning and etching the interconnect layer (Figs. 7-9).

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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Any inquiry concerning communications from the examiner should be directed to Jeff Vockrodt at (703) 306-9144 who can be reached on weekdays from 9:30 am to 5:00 pm EST. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Amir Zarabian, can be reached at (703) 308-4905.

The fax numbers for this Group are (703) 305-3432, (703) 308-7722, (703) 305-3431, and (703) 308-7724. Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist at (703) 308-0956.

March 31, 2003

J. Vockrodt

AMIR ZARABIAN
SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800